

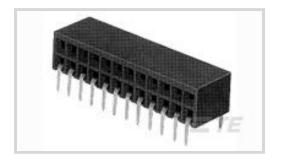
AMPMODU

TE Internal #: 87962-6 PCB Mount Receptacle, Right Angle, Board-to-Board, 14 Position, 2.54 mm [.1 in] Centerline, Header & Push-Push Assembly, Gold, Through Hole - Solder

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Receptacle

PCB Mount Orientation: Right Angle

Connector System: Board-to-Board

Number of Positions: 14

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type

Connector System

Header Type

PCB Mount Receptacle

Board-to-Board

Header & Push-Push Assembly

Sealable	No
Connector & Contact Terminates To	Printed Circuit Board
Configuration Features	
Stackable	No
PCB Mount Orientation	Right Angle
Number of Positions	14
Number of Rows	2
Body Features	
Connector Profile	Standard
Primary Product Color	Natural
Contact Features	
Contact Protection Type	Closed Entry Housing
Mating Square Post Dimension	.64 mm[.025 in]
PCB Contact Termination Area Plating Material Thickness	1.27 μm[50 μin]
Contact Shape & Form	Short Point

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PCB Contact Termination Area Plating Material	Gold
Contact Base Material	Phosphor Bronze
Contact Mating Area Plating Material	Gold
Contact Mating Area Plating Material Thickness	1.27 μm[50 μin]
Contact Type	Socket
Contact Current Rating (Max)	3 A
Termination Features	
Rectangular Termination Post & Tail Thickness	.2 mm[.008 in]
Rectangular Termination Post & Tail Width	.69 mm[.027 in]
Termination Post & Tail Length	2.92 mm[.115 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Guide Pins
PCB Mount Retention	Without
PCB Mount Alignment	With
Connector Mounting Type	Board Mount

Housing Features

Mating Entry Location	Side
Centerline (Pitch)	2.54 mm[.1 in]
Housing Material	Polyphenylene Sulfide (PPS)
Dimensions	
Connector Height	6.05 mm[.238 in]
Row-to-Row Spacing	2.54 mm[.1 in]
PCB Thickness (Recommended)	1.57 mm[.062 in]
Usage Conditions	
Housing Temperature Rating	Standard
Operating Temperature Range	-65 – 125 °C[-85 – 257 °F]
Operation/Application	
Solder Process Feature	Board Standoff
Circuit Application	Signal
Packaging Features	

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Packaging Quantity	135
Packaging Type	Tube
Product Compliance For compliance documentation, visit the product page on TE.com>	
EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Out of Scope
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JUL 2021 (219) Does not contain REACH SVHC
Halogen Content	BFR/CFR/PVC Free, but Br/Cl >900 ppm in other sources.
Solder Process Capability	Wave solder capable to 265°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Customers Also Bought



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TE Part #365717N001 S02-20-R-4CS1093



TE Part #626702N001 S02-20-R-6CS1093

Documents

Product Drawings 14 MODII HORZ DR CE 100CL/115

English

CAD Files 3D PDF

3D

Customer View Model ENG_CVM_CVM_87962-6_L.2d_dxf.zip

English

Customer View Model

ENG_CVM_CVM_87962-6_L.3d_igs.zip

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Customer View Model

ENG_CVM_CVM_87962-6_L.3d_stp.zip

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English